

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
KUHN-CHANG LIN	09/20/2011
I-KANG FU	09/20/2011
YORK TED SU	09/20/2011
RECEIVING PARTY DATA	
Name:	MEDIATEK SINGAPORE PTE. LTD.
Street Address:	NO. 1 FUSIONOPOLIS WALK, #3-01 SOLARIS
City:	SINGAPORE
State/Country:	SINGAPORE
Postal Code:	138628
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14307497
CORRESPONDENCE DATA	
Fax Number:	(925)835-5804
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	4085281442
Email:	zheng@imperiumpw.com
Correspondent Name:	ZHENG JIN
Address Line 1:	3043 VIN GRANDE CT.
Address Line 2:	3043 VIN GRANDE CT.
Address Line 4:	SAN JOSE, UNITED STATES 95135
ATTORNEY DOCKET NUMBER:	MDT-060-1C
NAME OF SUBMITTER:	ZHENG JIN
SIGNATURE:	/zheng jin/
DATE SIGNED:	06/18/2014
Total Attachments: 1	
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ASSIGNMENT OF PATENT APPLICATION

WHEREAS, we, Kuhn-Chang Lin, I-Kang Fu and York Ted Su (hereinafter referred to as ASSIGNORS), having post office addresses of: No. 7 Ln. 25, Beizhen St., West Dist., Chiayi City 600, Taiwan; 6F. No. 440, Wuxing St., Xinyi Dist., Taipei City 110, Taiwan; No. 255, Chung-Shan Rd., Chia-Yi City, Taiwan; respectively, are the joint inventors of the invention described and claimed in the specification forming part of the United States patent application entitled "METHOD OF TDM IN-DEVICE COEXISTENCE INTERFERENCE AVOIDANCE," executed herewith;

WHEREAS, MEDIATEK Singapore Pte. Ltd. (hereafter referred to as ASSIGNEE), a corporation organized under the laws of Singapore and having a place of business at 20, Ayer Rajah Crescent #04-01, Singapore (139964), is desirous of acquiring the entire right, title, and interest in and to the invention and in and to any letters patents that may be granted thereof in the United States and in any and all foreign countries;

NOW, THEREFORE, in exchange for good and valuable consideration, the receipt of which is hereby acknowledged, ASSIGNORS hereby sell, assign, and transfer unto said ASSIGNEE, the entire right, title, and interest in and to said invention, said application and any and all letters patents which may be granted for said invention in the United States of America and its territorial possessions and in any and all foreign countries, and in any and all divisions, reissues, and continuations thereof, including the right to file foreign applications directly in the name of ASSIGNEE and to claim priority rights deriving from said United States application to which said foreign applications are entitled by virtue of international convention, treaty, or otherwise, said invention, application and all letters patents on said invention to be held and enjoyed by ASSIGNEE and its successors and assigns for their use and benefit and of their successors an assigns as fully and entirely as the same would have been held and enjoyed by ASSIGNORS had this assignment, transfer, and sale not been made. ASSIGNORS hereby authorize and request the Commissioner of Patents and Trademarks to issue all letters patents on said invention to ASSIGNEE. ASSIGNORS agree to execute all instruments and documents required for the making and prosecution of applications for United States and foreign letters patents on said invention, for litigation regarding said letters patents, or for the purpose of protecting title to said invention or letters patents therefor.

IN WITNESS WHEREOF, We have hereunto signed our names on the day and year set forth below.

Kuhn-Chang Lin
Inventor's Signature

Kuhn-Chang Lin
Inventor's Printed Name

2011.9.20
Date

I-Kang Fu
Inventor's Signature

I-Kang Fu
Inventor's Printed Name

2011.9.20
Date

York Ted Su
Inventor's Signature

York Ted Su
Inventor's Printed Name

2011.9.20
Date